

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: Takeshi Nogami et al.

Docket No. 075834.00509

Serial No.: Herewith

Customer No. 33448

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Title: ELECTROLYTIC POLISHING APPARATUS,
ELECTROLYTIC POLISHING METHOD, AND WAFER
SUBJECT TO POLISHING

PRELIMINARY AMENDMENT
ACCOMPANYING CONTINUATION APPLICATION

Mail Stop Patent Application
Commissioner of Patents
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S I R:

Please amend the application as follows: